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Website: https://zhengliu-research.github.io/

Zheng Liu

Education

- 02/2019- Princeton University, Ph.D. Electrical and Computer Engineering, GPA -3.84/4.0
- 05/2023 Advisor: Prof. Kaushik Sengupta. Bede Liu Best Ph.D Dissertation Award.
 - 13-15 University of California, Los Angeles, M.S. Electrical Engineering, GPA -3.7/4.0
 - 09-13 Peking University, Beijing, China, B.S. Electronics, B.A. Economics, GPA -3.7/4.0

Research Interest

High frequency integrated circuits, systems and AI/ML-driven algorithmic techniques for next-generation communication and sensing applications: 1) RF/mmWave/THz broadband high-efficiency power amplifiers; 2) Antenna array architecture and beamforming IC; 3) AI/ML enabled wireless chip inverse design methodology

Professional Experiences

- 10/2023- RF/mmWave IC research Engineer, Kilby Labs, Texas Instruments, Dallas, Texas, USA
- Present O Leading R&D efforts for GaN-on-Si power amplifier and module/package design for TI's inaugural RF GaN product line targeting 5G-FR3 wireless infrastructure.
 - O Developing 120GHz transceiver IC for fully integrated molecular clock system.
 - Serving as a liaison for university projects and contributing to proposal writing for new Kilby initiatives.
- 02/2019- Doctoral Researcher, Princeton University, Princeton, NJ, USA
- 05/2023 Developed multi-hierarchy techniques (device + architecture) for broadband high-efficiency PAs across 30-110GHz in SiGe, CMOS and InP HBT technologies.
 - Developed a frequency-agile array system using algorithmically synthesized non-periodic sparse array architecture and co-designing ultra-wideband beamforming front-end IC with antenna array packaging.
 - First demonstration of using AI to discover new architectures for wireless chips and enable rapid on-demand synthesis. This work laid the foundation for the group's acquisition of \$10 million in funding from the National Semiconductor Technology Center under the US CHIPS and Science Act.
- 05/2022 Cellular RF Engineering Intern, Apple, Inc, San Diego, California, USA
 - 08/22 Investigated phased array receiver architecture enabled by phase shifter innovation in advanced CMOS.
- 05/2015 Senior Electrical Engineer, Skyworks Solutions, Inc., Thousand Oaks, California, USA
- 11/2018 Served as the core PA designer for an LTE Band 42 envelope-tracking push-pull PA engine, driving mass production with over 30 million units shipped for Apple's iPhone 8/X in the Japan market.
 - O Developed a 3.3 to 4.2 GHz linear Doherty PA for 5G N77 wireless communication. The design becomes Skyworks's first 5G prototype in $Sky5^{TM}$ product portfolio. Shipped over 10 million parts.

Academic Awards

- 05/2023 Bede Liu Best Ph.D Dissertation Award (1 awardee annually in ECE), Princeton University
- 06/2022 Advanced Practice Paper Award (1st Author, Top 1/325), IEEE IMS 2022
- 07/2021 Best Student Paper Awards (Two papers, Both 1st Author, Top 6/314), IEEE IMS 2021
- 08/2020 Best Student Paper Award (Top 3/317), IEEE IMS 2020

- 01/2022 IEEE MTT-S Graduate Fellowship (10 awardees globally per year), IEEE
- 01/2022 ADI Outstanding Student Designer Award, Analog Devices, Inc
- 05/2022 Qualcomm Innovation Fellowship Finalist, Qualcomm, Inc.
- 12/2021 Yan Huo 94* Graduate Fellowship, Princeton University
- 04/2017 Excellent Performance Award, Skyworks Solutions, Inc.

Journal Publications

- J1. Zheng Liu and K.Sengupta. "A 44-64 GHz mmWave Broadband Linear Doherty PA in Silicon with Quadrature Hybrid Combiner and Non-Foster Impedance Tuner", IEEE Journal of Solid-State Circuits (JSSC), Aug, 2022
- J2. Emir Ali Karahan, **Zheng Liu*** and Kaushik Sengupta et al. "Deep-Learning-Based Inverse-Designed Millimeter-Wave Passives and Power Amplifiers", IEEE Journal of Solid-State Circuits (**JSSC**), May, 2023 (* Corresponding author)
- J3. **Zheng Liu** et al. "A 42-62 GHz Transformer-based Broadband mm-Wave InP PA with Second Harmonic Waveform Engineering and Enhanced Linearity", IEEE Transactions on Microwave Theory and Techniques (**TMTT**). (**Invited**), Jan, 2021
- J4. **Zheng Liu**, E Karahan and K.Sengupta." A 36-91 GHz Broadband Beamforming Transmitter Architecture with Phase Error between 1.2-2.8° for Joint Communication and Sensing", IEEE Transactions on Microwave Theory and Techniques (**TMTT**), Oct, 2023 (**TMTT featured article**)
- J5. Emir Karahan, **Zheng Liu**, Aggraj Gupta, Zijian Shao, Jonathan Zhou and Kaushik Sengupta "Deeplearning Enabled Generalized Inverse Synthesis of Multi-Port Radio-frequency and Sub-Terahertz Integrated Circuits", **Nature Communications** (in press).
- J6. Zheng Liu et al "Deep Learning enabled Inverse Design of 30-94 GHz Psat,3dB SiGe-based PA supporting Multi-Gbps Concurrent Multi-band Operation", IEEE Microwave and Wireless Component Letter, May 2022, (IMS2022 Advanced Practice Paper Award (Top1/325), Best student paper finalist, MWCL Special Issue of "Top 50 IMS 2021 Papers")
- J7. Zheng Liu, T.Sharma and K.Sengupta. "80-110 GHz Broadband Linear PA with 33% peak PAE and Comparison of Stacked Common-Base and Common-Emitter PA in InP", IEEE Microwave and Wireless Component Letter, May 2021. (IEEE IMS2021 Best student paper award (3rd place, Top6/314), MWCL Special Issue of "Top IMS 2021 Papers")
- J8. Zheng Liu et al "A Compact SiGe Stacked Common-Base Dual-band PA with 20/18.8dBm Psat at 36/64 GHz Supporting Concurrent Modulation", IEEE Microwave and Wireless Component Letter, March 2022.(MWCL Special Issue of "Top 50 IMS 2021 Papers")
- J9. Zheng Liu, Y.Yu and K.Sengupta. "A 44-64 GHz Broadband 90° Hybrid Doherty PA with Quasi Non-Foster Tuner in 0.13μm SiGe", IEEE Microwave and Wireless Component Letter, May 2021. (IEEE IMS2021 Best student paper award (3rd place, Top6/314), MWCL Special Issue of "Top IMS 2021 Papers",)
- J10. **Zheng Liu**, T Sharma and K.Sengupta. "Stacked Common-base vs Common-emitter mmWave PA Cells and 68-105 GHz Broadband Asymmetrical PA in 250nm InP HBT", IEEE Access, Feb,2023
- J11. Wynand Lambrechts, **Zheng Liu** et al. "Intelligent Integrated Circuits and Systems for 5G/6G Telecommunications" IEEE Access 2024

- J12. Xiaolong Huang*, **Zheng Liu***, E.Krahan, K.Sengupta "Synthesized Design of Millimeter-Wave Low-Loss Wideband Bandpass Filter and Filtering Impedance Transformer in 90-nm BiCMOS Technology", IEEE Journal of Microwave (under review, * co-first authors).
- J13. Sherif Ghozzy, Muhamed Allam, Emir Karahan, **Zheng Liu**, Kaushik Sengupta "Towards milliWattlevel Integrated sub-Terahertz Kramers-Kronig Receivers with Nonlinear Analog and Mixed-signal Computing", **Nature Electronics** (under review).
- J14. **Zheng Liu**, Emir Ali Karahan, Zijian Shao, Sherif Ghozzy, Muhamed Allam, Xiaolong Huang and Kaushik Sengupta. "Frequency-agile 120 element Aperiodic Sparse Transmitter Phased Array across 36-98 GHz" (In preparation)
- J15. Xiaolong Huang and **Zheng Liu**. "Low-Cost W-Band Dual-Mode SIW Bandpass Filters Using Commercially Available Printed-Circuit-Board Technology", Electronics 12.17 (2023): 3624.
- J16. Yuhan Wang, **Zheng Liu**, Qingyu Liu, Lingyang Song "Intelligent Omni-Surfaces for Anti-Jamming Wireless Communications: Simultaneous Information Beamforming and Jamming Cancellation", IEEE Transactions on Wireless Communication (under review).

Conference Publications

- C1. **Zheng Liu**, Emir Karahan and K.Sengupta. "A 36-91 GHz 35 dB Gain Tx Phased-Array Beamformer with Low RMS Phase Error of 1.24-2.8° Supporting 10.8 Gbps 64QAM in 90 nm SiGe", IEEE 49th European Solid-State Circuits Conference (ESSCIRC), Sept, 2023.
- C2. **Zheng Liu**, T.Sharma, K.Sengupta "Transformer-Based Broadband High Efficiency mm-Wave InP Power Amplifier with Linearity Enhancement", IEEE IMS 2020 (**Late Breaking News paper**)
- C3. **Zheng Liu**, E.Emir, K.Sengupta "A 30-97 GHz Psat,3dB Broadband PA with 18.5-21.5dBm Psat and 18-26% PAE in 90nm SiGe Supporting Concurrent Multi-Band Operation", IEEE European Microwave Integrated Circuits Conference 2022.
- C4. **Zheng Liu** and K.Sengupta. "A 30-88 GHz Phase Shifter with Broadband 90° Hybrid- Marchand Balun Network and Common-base Buffer Achieving 1.34-3.1° RMS Phase Error in 90 nm SiGe", IEEE IMS 2023.
- C5. Sherif Ghozzy, Muhamed Allam, Emir Karahan, **Zheng Liu**, Kaushik Sengupta "A mmWave/Sub-THz Synthesizer-free Coherent Receiver With Phase Reconstruction Through Analog Kramer-Kronig Processing", International Solid-State Circuits Conference (**ISSCC**) 2024.
- C6. Jonathan Zhou, Emir Ali Karahan, Zheng Liu, Kaushik Sengupta "AI-enabled Design Space Discovery and End-to-end Synthesis for RFICs with Reinforcement Learning and Inverse Methods Demonstrating mmWave/sub-THz PAs between 30-120 GHz", to be appear in International Solid-State Circuits Conference (ISSCC) 2025.
- C7. T.Sharma*, **Zheng Liu***, C.R.Chappidi, H.Saeidi, S.Venkatesh, K.Sengupta "Broadband PA Architectures with Asymmetrical Combining and Stacked PA Cells across 50-70GHz and 64-110GHz in 250nm InP", IEEE IMS 2020 (Equally contributing authors)
- C8. C.R.Chappidi, T.Sharma, **Zheng Liu**, K.Sengupta "Load Modulated Balanced mm-Wave CMOS PA with Integrated Linearity Enhancement for 5G Applications", IEEE IMS 2020.(**Best student paper award (2nd place, Top2/317))**
- C9. Xiaolong Huang, **Zheng Liu**, E.Karahan, K.Sengupta "A Millimeter-Wave Low-Loss On-chip Filter Design Using A Wideband Synthesis Method in 90-nm SiGe BiCMOS Process" IEEE IMS 2024 (**Advanced Practice Paper Award Finalist**)

- C10. E. A. Karahan, Zheng Liu, and K. Sengupta, "Deep Learning Enabled Generalized Synthesis of Multi-Port Electromagnetic Structures and Circuits for mmWave Power Amplifiers" IEEE IMS 2024 (MWCL Special Issue of "Top 50 IMS 2024 Papers", give up the opportunity)
- C11. Kun Chen, **Zheng Liu**, Xuelin Hong, Ruinan Chang, Weimin Sun "Balun Modeling for Differential Amplifiers", WCECS 2019
- C12. Eric C. Blow, Chaoran Huang, **Zheng Liu**, Samuel J. Markoff, Paul R. Prucnal "Silicon Photonic Weights for Microwave Photonic Canceller", CLEO 2020
- C13. XY zhou, WS Chan, T Sharma, J Xia, **Zheng Liu**, SC Chen, WJ Feng. "High Efficiency, Extended Back-off Range Doherty Power Amplifier Using A Three Port Harmonic Injection Network" IEEE APMC 2020
- C14. XY zhou, WS Chan, WJ Feng, XH F, T Sharma, **Zheng Liu**. "Bandwidth Enhanced Doherty Power Amplifier Based on Coupled Phase Compensation Network With Specific Optimal Impedance" IEEE IWS 2020
- C15. E. A. Karahan, J. Zhou, **Zheng Liu**, Z. Shao, S. Fisher and K. Sengupta, "Deep Learning Enabled Design of RF/mmWave IC and Antennas" 2024 IEEE MWSCAS
- C16. K. Sengupta, E. A. Karahan and **Zheng Liu**, "Deep Learning enabled mmWave PA and Antenna Design," 2022 IEEE RFIT.(**Invited**)

Patents

- P1. **Zheng Liu** and Siraj Akhtar "Broadband Power Amplifier Combiner", U.S. patent application, 18,651,514
- P2. C.R.Chappidi, T.Sharma, **Zheng Liu**, K.Sengupta. "Load Modulated Balanced Power Amplifier Integrated Circuit Including Transformer-Based Hybrid Splitter/Combiner" U.S. patent granted, 11,949,390.
- P3. **Zheng Liu**, Emir Karahan, K.Sengupta. "Machine learning enabled inverse design of power amplifier" U.S. patent application, 18,073,482.
- P4. **Zheng Liu**, K.Sengupta. "Topologies and methods for ultra-broadband/multi-band planar phased array antenna with reduced side lobe levels across wide range of beam steering" U.S. patent application, 63,325,706
- P5. **Zheng Liu**, K.Sengupta. "Broadband and multi-band planar antenna array architectures" U.S. patent application, 18,886,714.
- P6. **Zheng Liu**, Siraj Akhtar. "Compact reconfigurable quadrature hybrid" U.S. patent application (To be filed)
- P7. **Zheng Liu**, Ali Omar Hassan. "Ultra-broadband irregular reflective array" U.S. patent application (To be filed)
- P8. Emir Karahan, **Zheng Liu**, Jonathan Zhou and Kaushik Sengupta "Deep Learning Enabled Generalized Synthesis of Multi-Port Electromagnetic Structures and Circuits for Radio-Frequency Systems", U.S. patent application, 63,660,874

Posters and Workshops

W1. **Zheng Liu** et al "mm-Wave 5G Power Amplifiers : Bandwidth, Back-off Efficiency and VSWR Tolerance." 2019 TxACE Symposium Poster Session, Dallas, TX, Oct 2019

- W2. **Zheng Liu** et al "Load Modulated Balanced mm-Wave CMOS PA with Integrated Linearity Enhancement for 5G Applications." 2020 AMS-CSD/TxACE Symposium Poster Session, Dallas, TX, Oct 2020
- W3. **Zheng Liu** et al "Universal and Aperiodic Array Architectures for Joint Sensing and Communication from 10-100+ GHz", NextG Symposium Poster Session, Princeton, NJ, March 2023
- W4. **Zheng Liu** et al "Universal Frequency-Agnostic Ultrabroadband Antennas and Antenna Arrays", Boston THz workshop (MIT,Brown,Rice,Princeton and Northeast), Boston, MA, April 2023

Invited Talks

T1 "AI-Driven mmWave Beamforming Transmitter Architecture with Over an Octave Bandwidth for Joint Communication and Sensing"

Invited presentation at 2025 IEEE Radio and Wireless Week (RWW), Puerto Rico, USA, Jan, 2015.

T2 "Universal Spectrally Agile and Energy Efficient Transmitter Architectures and Nonperiodic Arrays at mmWave"

Invited seminar at University of Florida, Electrical and Computer Engineering Department, March 2024.

Invited seminar at University of Electronic Science and Technology of China, Chengdu, China, Jun 2023.

Invited seminar at Kilby Labs, Texas Instruments Inc, Dallas, USA, April 2023.

Invited seminar at Nokia Corporation, San Jose, USA, April 2023.

Invited seminar at Samsung Research America, San Jose, USA, March 2023.

Invited seminar at Peking University, Beijing, China, Jan 2023.

Invited seminar at Fudan University, Shanghai, China, Jan 2023.

T3 "A Doherty Power Amplifier With Load Mismatch Tolerance for LTE Low-Band Handset Application"

Invited seminar at Skyworks Solutions Inc, Thousand Oaks, USA, Jan, 2017.

Teaching and Mentoring

Fall 20 Wireless and High Speed Integrated Circuits and Systems (ELE582)

Engaged in the conceptualization, guidance, and evaluation of the final graduate student high-speed circuit design project. Received a nomination for a graduate school teaching award.

Spring 21 Electronic Circuits: Devices to ICs (ELE304), Teaching Assistant

Migrated the design project platform to a web-based Linux environment to facilitate seamless and expedited remote student access during the pandemic.

20-23 Mentor of Junior Graduate Students

Emir Ali Karahan: mmWave Doherty Power Amplifier in HBT Technology, guiding his first tapeout and high frequency measurement.

Tyler Blundo: Reconfigurable Metasurfaces With Integrated Sensing, guiding optimization and PCB design. Developed instructional videos and documented tutorials covering high-frequency measurements, PDK installation, and active/passive circuit design flow. These tutorials continue to be utilized in the IMRL lab.

16-18 Mentor of Industry Internship Students

Zhengliu Zhou: Development of transformer 3D parametric geometry model in HFSS at Skyworks. Xing Hu: Optimization of UHB transformer on IPD technology for PA output matching at Skyworks. Yuhan Zheng: Load modulated balanced PA development using GaN-on-Si technology at TI Kilby Labs.

Technical Skills

Technical Circuit design tools: Cadence Virtuoso, ADS, Altium Designer. EM design tools: HFSS, Skills Momentum simulator, EMX, RFpro. Programming: Matlab, Python, SCPI

Lab Experiences with various mmWave/RF validation and instruments including probing system, ac-Skills tive/passive load-pull system, spectrum analyzer, VNA and calibration, vector signal analyzer, stability test, far-field antenna measurement in anechoic chamber.

Press/Media Coverage

Deep learning for RF chip design, Deep learning approach to wireless chip design wins best paper at International Microwave Symposium

IEEE Fellowship, Flexible designs for high-speed wireless systems earn IEEE honors for two grad students

Yan Huo 94* Fellowship, Yan Huo *94 fellowship powers advances in wireless sensing, networked systems and 2D electrons

Best Thesis Award, 2023 Graduate Awards

Efficient 5G device, Researchers win best student paper for work making 5G devices more efficient IEEE T-MTT Featured Article, Frequency agile beanmformer work is selected as featured article in IEEE T-MTT journal

Professional/Community Service

Technical Program Committee (TPC), 2025 IEEE International Microwave Symposium (IMS)

Technical Committee Affiliate Member, *IEEE Microwave Theory & Technology Society (MTT-S) Technical Committee (TC-14 on Microwave and mmWave Integrated Circuits Committee)*

Student Abassador, IEEE Microwave Theory & Technology Society (MTT-S)

Reviewer, IEEE Journal of Solid-State Circuits

Reviewer, IEEE Transactions on Microwave Theory and Techniques

Reviewer, IEEE Transactions on Circuits and Systems I: Regular Papers

Reviewer, IEEE Solid-State Circuits Letters

Reviewer, IEEE Microwave and Wireless Components Letters

Reviewer, IEEE Access

Reviewer, IEEE Transactions on Components, Packaging and Manufacturing Technology

Deputy Reviewer, 2025 IEEE International Solid State Circuits Conference (ISSCC)-RF subcommittee

References

Contact information available upon request.

Prof.Kaushik Sengupta, Department of Electrical and Computer Engineering, Princeton University Prof.Mau-Chung Frank Chang, Department of Electrical and Computer Engineering, UCLA Prof.Minjie Chen, Department of Electrical and Computer Engineering, Princeton University Prof.Suresh Venkatesh, Department of Electrical and Computer Engineering, NC State University Dr.Yorgos Palaskas, Apple, Inc